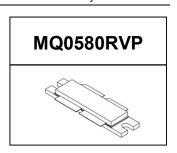
800W, 50V High Power RF LDMOS FETs

Description

The MQ0580RVP is a 800W capable, highly rugged, unmatched LDMOS FET, designed for commercial and industrial applications from 200MHz up to 500MHz, supporting both pulse and CW applications.

It is featured for industry leading high power and high ruggedness, suitable for Industrial, Scientific and Medical application, as well as VHF communication, UHF TV and Aerospace applications.



Application data at 325MHz narrow band with device soldered

| Freq(MHz) | Voltage(V) | Signal type | Pin(dBm) | Pout(W) | Power Gain(dB) | Eff(%) |
|-----------|------------|-------------|----------|---------|----------------|--------|
| 325 | 50 | CW | 42.5 | 809 | 16.5 | 74 |

Application data in 370-470MHz wide band with device soldered

VDS=50V VGS=3.31V IDQ=300Ma Signal mode: Pulse Width=100us, DutyCyce=10%

| Freq(MHz) | Pin(dBm) | Pout(dBm) | Pout(W) | IDS(A) | Power Gain(dB) | Eff(%) |
|-----------|----------|-----------|---------|--------|----------------|--------|
| 370 | 41.96 | 59.12 | 816.6 | 3.0 | 17.16 | 60 |
| 390 | 40.91 | 58.83 | 763.8 | 2.79 | 17.92 | 61.35 |
| 410 | 41.81 | 58.62 | 727.8 | 2.68 | 16.81 | 61.16 |
| 430 | 42.05 | 58.61 | 726.1 | 2.48 | 16.56 | 66.62 |
| 450 | 42.05 | 58.02 | 633.9 | 2.27 | 15.97 | 64.35 |
| 470 | 41.99 | 57.88 | 613.8 | 2.4 | 15.89 | 58.45 |

Features

- High breakdown voltage enable high ruggedness
- High Efficiency and Linear Gain Operations
- Integrated ESD Protection
- Large Positive and Negative Gate/Source Voltage Range for Improved Class C Operation
- Excellent thermal stability, low HCl drift
- Compliant to Restriction of Hazardous Substances (RoHS) Directive 2002/95/EC

Table 1. Maximum Ratings

| Rating | Symbol | Value | Unit |
|--------------------------------|------------------|-------------|------|
| DrainSource Voltage | V _{DSS} | 115 | Vdc |
| GateSource Voltage | V_{GS} | -10 to +10 | Vdc |
| Operating Voltage | V_{DD} | +55 | Vdc |
| Storage Temperature Range | Tstg | -65 to +150 | °C |
| Case Operating Temperature | Tc | +150 | °C |
| Operating Junction Temperature | TJ | +225 | °C |

Table 2. Thermal Characteristics

| Characteristic | Symbol | Value | Unit | |
|--|--------|-------|------|--|
| Thermal Resistance, Junction to Case ,Case Temperature | Davo | 0.18 | °C/W | |
| 85°C, 800W CW, 50 Vdc, IDQ = 240 mA | R⊕JC | 0.16 | | |

Document Number: MQ0580RVP Preliminary Datasheet V1.1

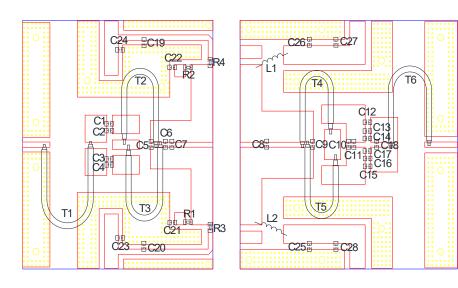
Table 3. ESD Protection Characteristics

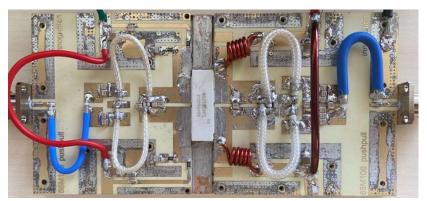
| Test Methodology | Class |
|-----------------------------------|---------|
| Human Body Model (per JESD22A114) | Class 2 |

Table 4. Electrical Characteristics (TA = 25 $^{\circ}$ C unless otherwise noted)

| Characteristic | Symbol | Min | Тур | Max | Unit |
|--|----------------------|-----------|------|-----|-------|
| DC Characteristics | | | | | |
| Drain-Source Voltage | N/ | | 445 | | V |
| V_{GS} =0V, I_{DS} =1.0mA | V _{(BR)DSS} | | 115 | | V |
| Zero Gate Voltage Drain Leakage Current | | | | 4 | Δ. |
| $(V_{DS} = 50V, V_{GS} = 0 V)$ | I _{DSS} | <u> </u> | | 1 | μΑ |
| Gate—Source Leakage Current | | | | 1 | |
| $(V_{GS} = 10 \text{ V}, V_{DS} = 0 \text{ V})$ | I _{GSS} | | | 1 | μΑ |
| Gate Threshold Voltage | V (4) | | 2.54 | | V |
| $(V_{DS} = 50V, I_D = 600 \mu A)$ | V _{GS} (th) | <u>——</u> | 2.54 | | V |
| Gate Quiescent Voltage | N/ | | 3 | | V |
| (V_{DD} = 50 V, I_{D} = 240 mA, Measured in Functional Test) | $V_{GS(Q)}$ | | | | V |
| Drain source on state resistance | Dda(an) | | 54 | | mΩ |
| (V_{DS} = 0.1V, V_{GS} = 10 V) Each section side of device measured | Rds(on) | | 54 | | 11177 |
| Common Source Input Capacitance | C _{ISS} | | 220 | | pF |
| (V _{GS} = 0V, V _{DS} =50 V, f = 1 MHz) Each section side of device | | | | | |
| measured | | | | | |
| Common Source Output Capacitance | Coss | | 85 | | pF |
| (V_{GS} = 0V, V_{DS} =50 V, f = 1 MHz) Each section side of device | | | | | |
| measured | | | | | |
| Common Source Feedback Capacitance | C _{RSS} | | 2.5 | | pF |
| ($V_{GS} = 0V$, $V_{DS} = 50 V$, f = 1 MHz) Each section side of device | | | | | |
| measured | | | | | |

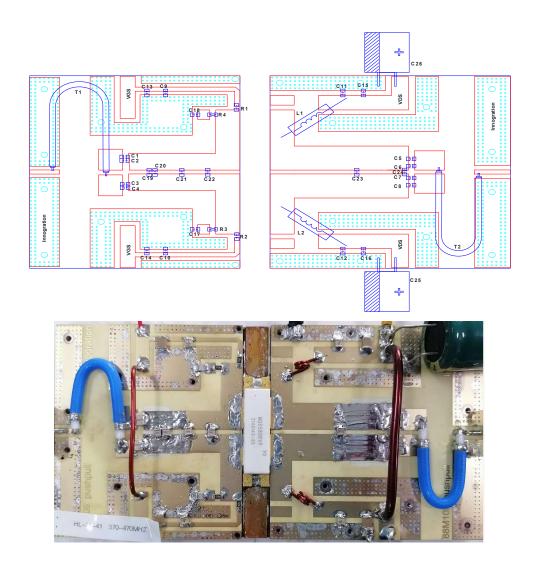
Reference Circuit of Test Fixture (325MHz) (Layout file upon request) PCB: Roger 4350B, 30mils





| Component | Description | Suggested |
|---|-----------------------------|--------------|
| | | part type |
| C1,C2,C3,C4,C12,C13,C14,C15,C16,C17,C19,C20,C25,C26 | 150pF | DLC75B |
| C5,C6 | 30pF | DLC75B |
| C7 | 39pF | DLC75B |
| C8,C9 | 6.8Pf | DLC75B |
| C10,C18 | 2Pf | DLC75B |
| C11 | 0.5pF | DLC75B |
| C21,C22 | 1000pF | DLC75B |
| C23,C24 | 10nF | 1812 |
| C27,C28 | 10uF | 10uF/50V |
| R1,R2,R3,R4 | Chip Resistor,15ohm | 1206 |
| T1 | 50ohm, Line length=70mm | SF-086-50 |
| T2,T3 | 12.5ohm, Line length=70mm | SFF-12.5-1.5 |
| T4,T5 | 12.5ohm,Line length=70mm | SFF-12.5-3 |
| Т6 | 50ohm, Line length=70mm | RG-402-3 |
| L1,L2 | 5turns, Inside diameter 5mm | |

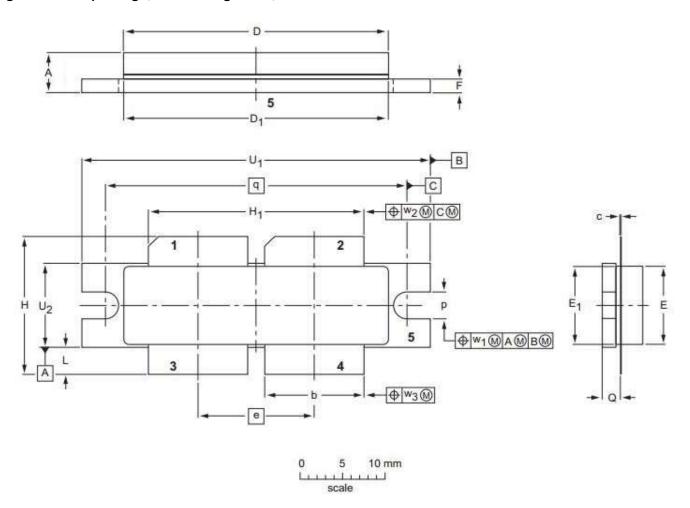
Reference Circuit of Test Fixture (370-470MHz) (Layout file upon request) PCB: Roger 4350B, 30mils



| Part | description | Model | | |
|-------------|---|------------------------------|--|--|
| C1~C12 | 200pF | DLC70B | | |
| C13~C16 | 10nF | Ceramic multilayer capacitor | | |
| C17,C18 | 1000pF | DLC70B | | |
| C19,C20 | 5.6pF | DLC70B | | |
| C21,C22 | 18pF | DLC70B | | |
| C23,C24 | 10pF | DLC70B | | |
| C25,C26 | 4700uF/63V | Electrolytic Capacitor | | |
| R1,R2,R3,R4 | 9.1 Ω | Chip Resistor | | |
| T1,T2 | 25ohm/50mm | | | |
| L1, L2 | 2turns,绕径 5mm 线径 1mm | DIY air core inductance | | |
| PCB | 0.762mm [0.030"] thick, εr=3.50, Rogers 4350B, 1 oz. copper | | | |

Package Outline

Flanged ceramic package; 2 mounting holes; 4 leads (1, 2—DRAIN, 3, 4—GATE, 5—SOURCE)



| UNIT | Α | b | С | D | D ₁ | е | E | E ₁ | F | Н | H ₁ | L | р | Q | q | U ₁ | U ₂ | W ₁ | W_2 | W ₂ |
|--------|-------|-------|-------|-------|----------------|-------|-------|----------------|-------|-------|----------------|-------|-------|-------|-------|----------------|----------------|----------------|----------|----------------|
| | 4.7 | 11.81 | 0.18 | 31.55 | 31.52 | 13.72 | 9.50 | 9.53 | 1.75 | 17.12 | 25.53 | 3.48 | 3.30 | 2.26 | 35.56 | 41.28 | 10.29 | 0.25 | 0.51 | 0.25 |
| mm | 4.2 | 11.56 | 0.10 | 30.94 | 30.96 | 13.72 | 9.30 | 9.27 | 1.50 | 16.10 | 25.27 | 2.97 | 3.05 | 2.01 | 33.30 | 41.02 | 10.03 | 0.25 | 0.51 | 0.25 |
| inches | 0.185 | 0.465 | 0.007 | 1.242 | 1.241 | 0.540 | 0.374 | 0.375 | 0.069 | 0.674 | 1.005 | 0.137 | 0.130 | 0.089 | 4 400 | 1.625 | 0.405 | 0.04 | 0.00 | 0.04 |
| | 0.165 | 0.455 | 0.004 | 1.218 | 1.219 | 0.540 | 0.366 | 0.365 | 0.059 | 0.634 | 0.995 | 0.117 | 0.120 | 0.079 | 1.400 | 1.615 | 0.395 | 0.01 | 0.02 0.0 | 0.01 |

| OUTLINE | | REFERENCE | EUROPEAN | ISSUE DATE | |
|---------|-----|-----------|----------|------------|------------|
| VERSION | IEC | JEDEC | JEITA | PROJECTION | IOOOE BATE |
| PKG-D4E | | | | | 03/12/2013 |

Document Number: MQ0580RVP Preliminary Datasheet V1.1

Revision history

Table 5. Document revision history

| Date | Revision | Datasheet Status |
|------------|----------|--------------------------------|
| 2021/9/10 | Rev 1.0 | Preliminary Datasheet |
| 2021/10/25 | Rev 1.1 | MQ0580VP upgraded to MQ0580RVP |
| | | |

Application data based on ZL-21-21, HL-21-41

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